2SK4029

Silicon N-channel MOSFET

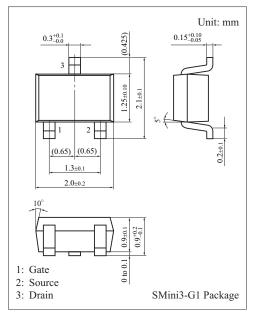
For switching circuits

■ Features

- High-speed switching
- Low ON resistance Ron
- Incorporating a built-in gate protection-diode

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Drain-source surrender voltage	V _{DSS}	25	V	
Gate-source surrender voltage	V _{GSS}	±12	V	
Drain current	I_D	1.0	A	
Peak drain current	I_{DP}	2.0	A	
Power dissipation	P_{D}	500	mW	
Channel temperature	T _{ch}	125	°C	
Storage temperature	T _{stg}	-55 to +125	°C	



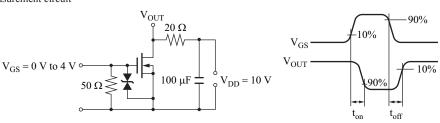
Marking Symbol: 5Z

■ Electrical Characteristics $T_a = 25$ °C±3°C

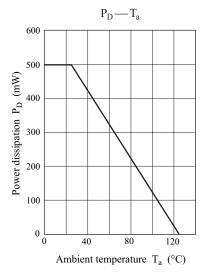
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Drain-source surrender voltage	V _{DSS}	$I_{\rm D} = 1 \text{ mA}, V_{\rm GS} = 0$	25			V
Drain-source cutoff current	I_{DSS}	$V_{DS} = 20 \text{ V}, V_{GS} = 0$			1.0	μΑ
Gate-source cutoff current	I_{GSS}	$V_{GS} = \pm 8 \text{ V}, V_{DS} = 0$			±10	μΑ
Gate threshold voltage	V _{TH}	$I_D = 1 \text{ mA}, V_{DS} = 10 \text{ V}$	0.4	0.9	1.4	V
Drain-source ON resistance	R _{DS(on)}	$I_D = 0.5 \text{ A}, V_{GS} = 4.0 \text{ V}$		260	420	mΩ
		$I_D = 0.25 \text{ A}, V_{GS} = 2.5 \text{ V}$		350	550	
Forward transfer admittance	Y _{fs}	$I_D = 500 \text{ mA}, V_{DS} = 10 \text{ V}$		1.8		S
Short-circuit forward transfer capacitance (Common source)	C _{iss}	$V_{DS} = 10 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$		65		pF
Short-circuit output capacitance (Common source)	C _{oss}			35		pF
Reverse transfer capacitance (Common source)	C _{rss}			13		pF
Turn-on time *	t _{on}	$V_{DD} = 10 \text{ V}, V_{GS} = 0 \text{ V to 4 V}, I_D = 0.5 \text{ A}$		8		ns
Turn-off time *	t _{off}	$V_{DD} = 10 \text{ V}, V_{GS} = 4 \text{ V to } 0 \text{ V}, I_D = 0.5 \text{ A}$		30		ns

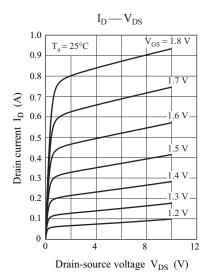
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

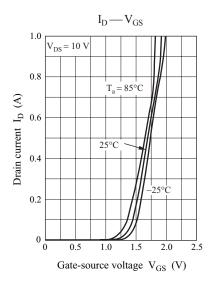
2. *: t_{on} , t_{off} measurement circuit

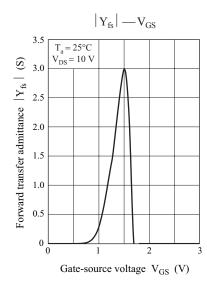


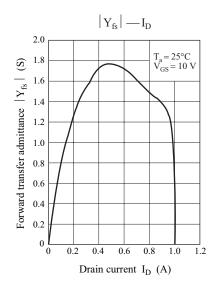
2SK4029 Panasonic

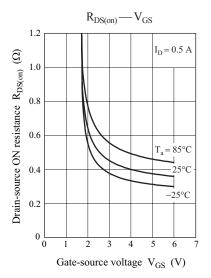












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